# Crystal oscillator

## **CRYSTAL OSCILLATOR SPXO**

SG-210S\*B

: 2 MHz to 60 MHz •Frequency range •Supply voltage : 1.5 V / 1.8 V / 2.5 V / 3.3 V

•Current consumption : 0.9 mA Typ.

(SEB: 1.8 V No load condition 48 MHz)

Standby(ST) •External dimensions : 2.5 × 2.0 × 0.8 mm •Operation temperature: +105 °C / +125 °C

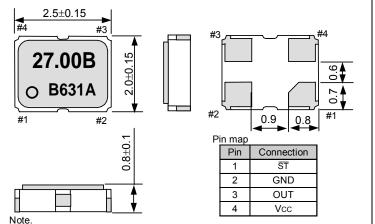


## Specifications (characteristics)

Item	Symbol	Specifications				O and the second	
		SG-210SGB	SG-210SEB	SG-210SDB	SG-210SCB	Conditions / Remarks	
Output frequency range	<b>f</b> o	2 MHz to 32 MHz 2 MHz to 60 MHz					
Supply voltage	Vcc	1.5 V Typ. 1.3 V to 1.7 V	1.8 V Typ. 1.6 V to 2.2 V	2.5 V Typ. 2.2 V to 3.0 V	3.3 V Typ. 2.7 V to 3.6 V		
Storage temperature	T_stg	-40 °C to +125 °C Storage as single product.				product.	
Operating temperature	T_use	-40 °C to +85 °C / -40 °C to +105 °C / -40 °C to +125 °C					
Frequency tolerance	f_tol	F: ±20 × 10 <sup>-6</sup>				-10 °C to +60 °C, fo ≤ 32 MHz, Vcc ±10%, except reflow drift.	
		B: ±50 × 10 <sup>-6</sup> , C: ±100 × 10 <sup>-6</sup>				-20 °C to +70 °C	
		L:±50 × 10 <sup>-6</sup> ,M:±100 × 10 <sup>-6</sup>			-40 °C to +85 °C		
		ı	1.200 10 ,11.2100 10			-40 °C to +105 °C	
		_	Z:±100 × 10 <sup>-6</sup> ,X:±150 × 10 <sup>-6</sup>			-40 °C to +125 °C	
Current consumption	Icc	1.0 mA Max.	1.6 mA Max.	2.4 mA Max.	3.0 mA Max.	No load condition	
		_	2.0 mA Max	3.0 mA Max.	4.0 mA Max.	No load condition +105 °C,+125 °C	
Stand-by current	I_std	0.3 μA Max.	0.5 μA Max.	1.0 µA Max.	1.0 μA Max.	ST =GND	
		-	1.6 µA Max.	2.4 µA Max.	3.0 µA Max.	ST =GND +105 °C,+125 °C	
Symmetry	SYM	45 % to 55 % 40 % to 60 %	45 % to 55 %	45 % to 55 %	45 % to 55 %	2 MHz≤f <sub>0</sub> ≤16 MH 16 MHz <f<sub>0≤32 MH</f<sub>	
		-	40 % to 60 %	40 % to 60 %		32 MHz <f<sub>0≤60 MH</f<sub>	Iz L CMOS ≤ 15 pF
		1	- 40 % to 60 %			+105 °C,+125 °C	
Output voltage	Vон	90 % Vcc Min.			Iон=-1 mA		
	Vol	10 % Vcc Max.			IoL= 1 mA		
Output load condition (CMOS)	L_CMOS	15 pF Max.					
Input voltage	Vih	80 % Vcc Min.			ST terminal		
	VIL	20 % Vcc Max.					
Rise time and Fall time	tr/ tf	5 ns Max.	4 ns Max.		Max.	+85 °C	20 % Vcc to 80 % Vcc
		- 7 ns Max			+105 °C,+125 °C	level,L_CMOS=15 pF	
Start-up time	t_str	3 ms Max.				t=0 at 90 % Vcc (+105 °C,+125 °C : 5 ms Max.)	
Frequency aging	f_aging	±3 × 10 <sup>-6</sup> / year Max.				+25 °C, First year, Vcc=1.5 V,1.8 V, 2.5 V, 3.3 V	

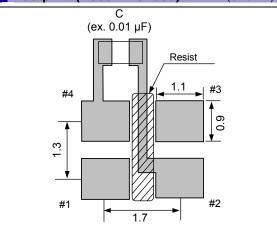
(Unit:mm)





ST pin = HIGH or "open" : Specified frequency output. ST pin = LOW: Output is high impedance, oscillation stops.

#### Footprint (Recommended) (Unit:mm)



To maintain stable operation, provide a 0.01uF to 0.1uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

## PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

## **WORKING FOR HIGH QUALITY**

In order provide high quality and reliable products and services than meet customer needs,

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ISO/TS16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



- ► Complies with EU RoHS directive.
  - \*About the products without the Pb-free mark.

    Contains Pb in products exempted by EU RoHS directive.

    (Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ The products have been designed for high reliability applications such as Automotive.

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